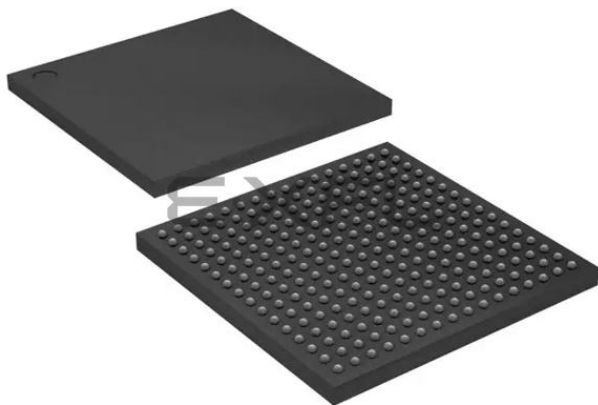




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### Understanding Embedded - FPGAs (Field Programmable Gate Array)

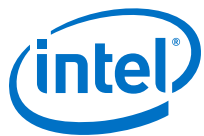
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

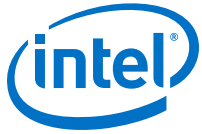
|                                |                                                                                                                                   |
|--------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|
| Product Status                 | Active                                                                                                                            |
| Number of LABs/CLBs            | 1000                                                                                                                              |
| Number of Logic Elements/Cells | 16000                                                                                                                             |
| Total RAM Bits                 | 562176                                                                                                                            |
| Number of I/O                  | 178                                                                                                                               |
| Number of Gates                | -                                                                                                                                 |
| Voltage - Supply               | 1.15V ~ 1.25V                                                                                                                     |
| Mounting Type                  | Surface Mount                                                                                                                     |
| Operating Temperature          | -40°C ~ 100°C (TJ)                                                                                                                |
| Package / Case                 | 256-LBGA                                                                                                                          |
| Supplier Device Package        | 256-FBGA (17x17)                                                                                                                  |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/intel/10m16dcf256i7g">https://www.e-xfl.com/product-detail/intel/10m16dcf256i7g</a> |



## Contents

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| Condition (V) | Overshoot Duration as % of High Time | Unit |
|---------------|--------------------------------------|------|
| 4.32          | 2.6                                  | %    |
| 4.37          | 1.6                                  | %    |
| 4.42          | 1.0                                  | %    |
| 4.47          | 0.6                                  | %    |
| 4.52          | 0.3                                  | %    |
| 4.57          | 0.2                                  | %    |

## Recommended Operating Conditions

This section lists the functional operation limits for the AC and DC parameters for Intel MAX 10 devices. The tables list the steady-state voltage values expected from Intel MAX 10 devices. Power supply ramps must all be strictly monotonic, without plateaus.

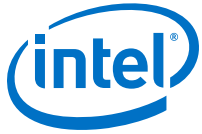
### Single Supply Devices Power Supplies Recommended Operating Conditions

**Table 6. Power Supplies Recommended Operating Conditions for Intel MAX 10 Single Supply Devices**

| Symbol                             | Parameter                                                              | Condition | Min        | Typ     | Max        | Unit |
|------------------------------------|------------------------------------------------------------------------|-----------|------------|---------|------------|------|
| V <sub>CC_ONE</sub> <sup>(1)</sup> | Supply voltage for core and periphery through on-die voltage regulator | —         | 2.85/3.135 | 3.0/3.3 | 3.15/3.465 | V    |
| V <sub>CCIO</sub> <sup>(2)</sup>   | Supply voltage for input and output buffers                            | 3.3 V     | 3.135      | 3.3     | 3.465      | V    |
|                                    |                                                                        | 3.0 V     | 2.85       | 3       | 3.15       | V    |
|                                    |                                                                        | 2.5 V     | 2.375      | 2.5     | 2.625      | V    |
|                                    |                                                                        | 1.8 V     | 1.71       | 1.8     | 1.89       | V    |
|                                    |                                                                        | 1.5 V     | 1.425      | 1.5     | 1.575      | V    |
| continued...                       |                                                                        |           |            |         |            |      |

(1)  $V_{CCA}$  must be connected to  $V_{CC\_ONE}$  through a filter.

(2)  $V_{CCIO}$  for all I/O banks must be powered up during user mode because  $V_{CCIO}$  I/O banks are used for the ADC and I/O functionalities.



**Table 15. OCT Variation after Calibration at Device Power-Up for Intel MAX 10 Devices**

This table lists the change percentage of the OCT resistance with voltage and temperature.

| Description                                        | Nominal Voltage | dR/dT (%/°C) | dR/dV (%/mV) |
|----------------------------------------------------|-----------------|--------------|--------------|
| OCT variation after calibration at device power-up | 3.00            | 0.25         | -0.027       |
|                                                    | 2.50            | 0.245        | -0.04        |
|                                                    | 1.80            | 0.242        | -0.079       |
|                                                    | 1.50            | 0.235        | -0.125       |
|                                                    | 1.35            | 0.229        | -0.16        |
|                                                    | 1.20            | 0.197        | -0.208       |

**Figure 1. Equation for OCT Resistance after Calibration at Device Power-Up**

$$\Delta R_V = (V_2 - V_1) \times 1000 \times dR/dV$$

$$\Delta R_T = (T_2 - T_1) \times dR/dT$$

$$\text{For } \Delta R_X < 0; MF_X = 1/(|\Delta R_X|/100 + 1)$$

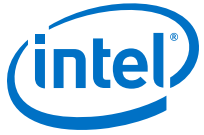
$$\text{For } \Delta R_X > 0; MF_X = \Delta R_X/100 + 1$$

$$MF = MF_V \times MF_T$$

$$R_{final} = R_{initial} \times MF$$

The definitions for equation are as follows:

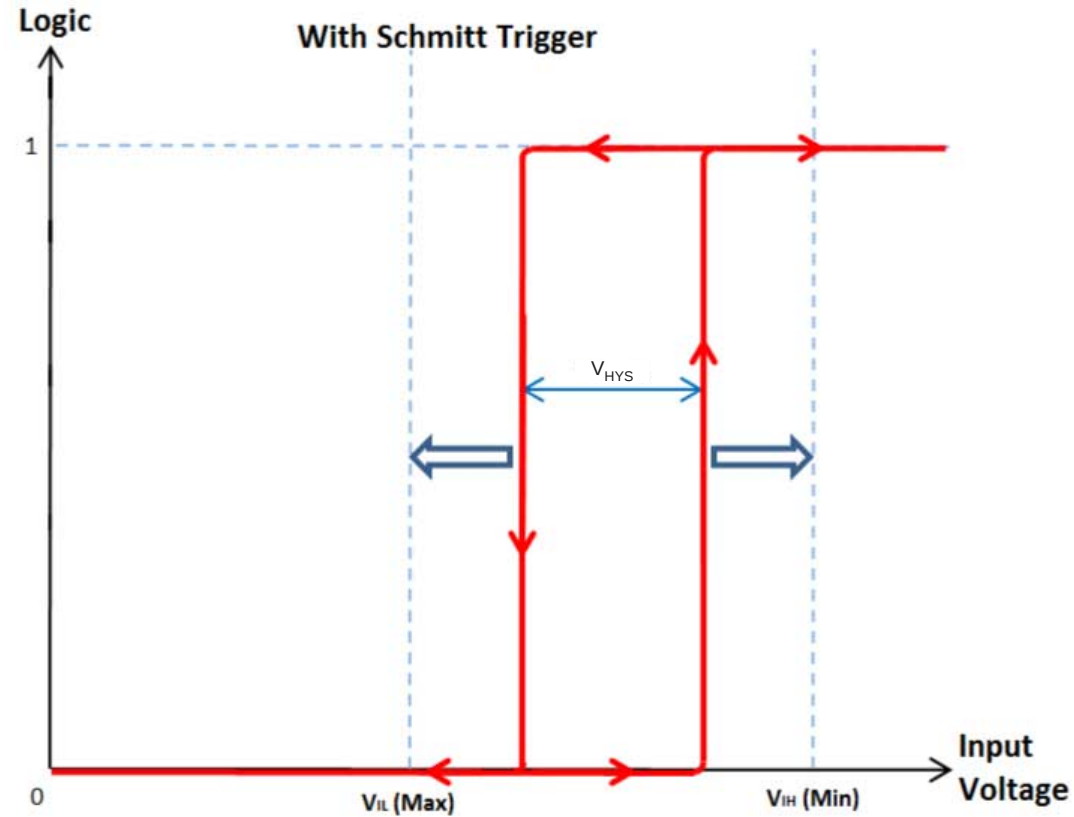
- $T_1$  is the initial temperature.
- $T_2$  is the final temperature.
- MF is multiplication factor.
- $R_{initial}$  is initial resistance.
- $R_{final}$  is final resistance.



**Table 19. Hysteresis Specifications for Schmitt Trigger Input for Intel MAX 10 Devices**

| Symbol           | Parameter                            | Condition                 | Minimum | Unit |
|------------------|--------------------------------------|---------------------------|---------|------|
| V <sub>HYS</sub> | Hysteresis for Schmitt trigger input | V <sub>CCIO</sub> = 3.3 V | 180     | mV   |
|                  |                                      | V <sub>CCIO</sub> = 2.5 V | 150     | mV   |
|                  |                                      | V <sub>CCIO</sub> = 1.8 V | 120     | mV   |
|                  |                                      | V <sub>CCIO</sub> = 1.5 V | 110     | mV   |

Figure 4. Schmitt Trigger Input Standard Voltage Diagram

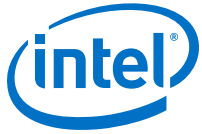


## I/O Standards Specifications

Tables in this section list input voltage ( $V_{IH}$  and  $V_{IL}$ ), output voltage ( $V_{OH}$  and  $V_{OL}$ ), and current drive characteristics ( $I_{OH}$  and  $I_{OL}$ ) for various I/O standards supported by Intel MAX 10 devices.

For minimum voltage values, use the minimum  $V_{CCIO}$  values. For maximum voltage values, use the maximum  $V_{CCIO}$  values.

You must perform timing closure analysis to determine the maximum achievable frequency for general purpose I/O standards.



## Single-Ended SSTL, HSTL, and HSUL I/O Reference Voltage Specifications

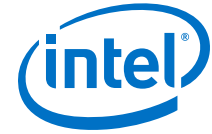
**Table 21. Single-Ended SSTL, HSTL, and HSUL I/O Reference Voltage Specifications for Intel MAX 10 Devices**

| I/O Standard         | V <sub>CCIO</sub> (V) |      |       | V <sub>REF</sub> (V)                        |                                         |                                             | V <sub>TT</sub> (V) <sup>(14)</sup> |                         |                          |
|----------------------|-----------------------|------|-------|---------------------------------------------|-----------------------------------------|---------------------------------------------|-------------------------------------|-------------------------|--------------------------|
|                      | Min                   | Typ  | Max   | Min                                         | Typ                                     | Max                                         | Min                                 | Typ                     | Max                      |
| SSTL-2 Class I, II   | 2.375                 | 2.5  | 2.625 | 1.19                                        | 1.25                                    | 1.31                                        | V <sub>REF</sub> - 0.04             | V <sub>REF</sub>        | V <sub>REF</sub> + 0.04  |
| SSTL-18 Class I, II  | 1.7                   | 1.8  | 1.9   | 0.833                                       | 0.9                                     | 0.969                                       | V <sub>REF</sub> - 0.04             | V <sub>REF</sub>        | V <sub>REF</sub> + 0.04  |
| SSTL-15 Class I, II  | 1.425                 | 1.5  | 1.575 | 0.49 × V <sub>CCIO</sub>                    | 0.5 × V <sub>CCIO</sub>                 | 0.51 × V <sub>CCIO</sub>                    | 0.49 × V <sub>CCIO</sub>            | 0.5 × V <sub>CCIO</sub> | 0.51 × V <sub>CCIO</sub> |
| SSTL-135 Class I, II | 1.283                 | 1.35 | 1.45  | 0.49 × V <sub>CCIO</sub>                    | 0.5 × V <sub>CCIO</sub>                 | 0.51 × V <sub>CCIO</sub>                    | 0.49 × V <sub>CCIO</sub>            | 0.5 × V <sub>CCIO</sub> | 0.51 × V <sub>CCIO</sub> |
| HSTL-18 Class I, II  | 1.71                  | 1.8  | 1.89  | 0.85                                        | 0.9                                     | 0.95                                        | 0.85                                | 0.9                     | 0.95                     |
| HSTL-15 Class I, II  | 1.425                 | 1.5  | 1.575 | 0.71                                        | 0.75                                    | 0.79                                        | 0.71                                | 0.75                    | 0.79                     |
| HSTL-12 Class I, II  | 1.14                  | 1.2  | 1.26  | 0.48 × V <sub>CCIO</sub><br><sup>(15)</sup> | 0.5 × V <sub>CCIO</sub> <sup>(15)</sup> | 0.52 × V <sub>CCIO</sub><br><sup>(15)</sup> | —                                   | 0.5 × V <sub>CCIO</sub> | —                        |
|                      |                       |      |       | 0.47 × V <sub>CCIO</sub><br><sup>(16)</sup> | 0.5 × V <sub>CCIO</sub> <sup>(16)</sup> | 0.53 × V <sub>CCIO</sub><br><sup>(16)</sup> |                                     |                         |                          |
| HSUL-12              | 1.14                  | 1.2  | 1.3   | 0.49 × V <sub>CCIO</sub>                    | 0.5 × V <sub>CCIO</sub>                 | 0.51 × V <sub>CCIO</sub>                    | —                                   | —                       | —                        |

<sup>(14)</sup> V<sub>TT</sub> of transmitting device must track V<sub>REF</sub> of the receiving device.

<sup>(15)</sup> Value shown refers to DC input reference voltage, V<sub>REF(DC)</sub>.

<sup>(16)</sup> Value shown refers to AC input reference voltage, V<sub>REF(AC)</sub>.



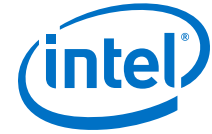
## Single-Ended SSTL, HSTL, and HSUL I/O Standards Signal Specifications

**Table 22. Single-Ended SSTL, HSTL, and HSUL I/O Standards Signal Specifications for Intel MAX 10 Devices**

To meet the  $I_{OL}$  and  $I_{OH}$  specifications, you must set the current strength settings accordingly. For example, to meet the SSTL-15 Class I specification (8 mA), you should set the current strength settings to 8 mA. Setting at lower current strength may not meet the  $I_{OL}$  and  $I_{OH}$  specifications in the datasheet.

| I/O Standard     | $V_{IL(DC)} (V)$ |                   | $V_{IH(DC)} (V)$  |     | $V_{IL(AC)} (V)$ |                   | $V_{IH(AC)} (V)$  |     | $V_{OL} (V)$          | $V_{OH} (V)$          | $I_{OL} (mA)$ | $I_{OH} (mA)$ |
|------------------|------------------|-------------------|-------------------|-----|------------------|-------------------|-------------------|-----|-----------------------|-----------------------|---------------|---------------|
|                  | Min              | Max               | Min               | Max | Min              | Max               | Min               | Max | Max                   | Min                   |               |               |
| SSTL-2 Class I   | —                | $V_{REF} - 0.18$  | $V_{REF} + 0.18$  | —   | —                | $V_{REF} - 0.31$  | $V_{REF} + 0.31$  | —   | $V_{TT} - 0.57$       | $V_{TT} + 0.57$       | 8.1           | -8.1          |
| SSTL-2 Class II  | —                | $V_{REF} - 0.18$  | $V_{REF} + 0.18$  | —   | —                | $V_{REF} - 0.31$  | $V_{REF} + 0.31$  | —   | $V_{TT} - 0.76$       | $V_{TT} + 0.76$       | 16.4          | -16.4         |
| SSTL-18 Class I  | —                | $V_{REF} - 0.125$ | $V_{REF} + 0.125$ | —   | —                | $V_{REF} - 0.25$  | $V_{REF} + 0.25$  | —   | $V_{TT} - 0.475$      | $V_{TT} + 0.475$      | 6.7           | -6.7          |
| SSTL-18 Class II | —                | $V_{REF} - 0.125$ | $V_{REF} + 0.125$ | —   | —                | $V_{REF} - 0.25$  | $V_{REF} + 0.25$  | —   | 0.28                  | $V_{CCIO} - 0.28$     | 13.4          | -13.4         |
| SSTL-15 Class I  | —                | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | —   | —                | $V_{REF} - 0.175$ | $V_{REF} + 0.175$ | —   | $0.2 \times V_{CCIO}$ | $0.8 \times V_{CCIO}$ | 8             | -8            |
| SSTL-15 Class II | —                | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | —   | —                | $V_{REF} - 0.175$ | $V_{REF} + 0.175$ | —   | $0.2 \times V_{CCIO}$ | $0.8 \times V_{CCIO}$ | 16            | -16           |
| SSTL-135         | —                | $V_{REF} - 0.09$  | $V_{REF} + 0.09$  | —   | —                | $V_{REF} - 0.16$  | $V_{REF} + 0.16$  | —   | $0.2 \times V_{CCIO}$ | $0.8 \times V_{CCIO}$ | —             | —             |
| HSTL-18 Class I  | —                | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | —   | —                | $V_{REF} - 0.2$   | $V_{REF} + 0.2$   | —   | 0.4                   | $V_{CCIO} - 0.4$      | 8             | -8            |
| HSTL-18 Class II | —                | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | —   | —                | $V_{REF} - 0.2$   | $V_{REF} + 0.2$   | —   | 0.4                   | $V_{CCIO} - 0.4$      | 16            | -16           |
| HSTL-15 Class I  | —                | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | —   | —                | $V_{REF} - 0.2$   | $V_{REF} + 0.2$   | —   | 0.4                   | $V_{CCIO} - 0.4$      | 8             | -8            |
| HSTL-15 Class II | —                | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | —   | —                | $V_{REF} - 0.2$   | $V_{REF} + 0.2$   | —   | 0.4                   | $V_{CCIO} - 0.4$      | 16            | -16           |

*continued...*



| I/O Standard | V <sub>CCIO</sub> (V) |     |       | V <sub>ID</sub> (mV) |     | V <sub>ICM</sub> (V) <sup>(18)</sup> |                                        |      | V <sub>OD</sub> (mV) <sup>(19)(20)</sup> |     |     | V <sub>OS</sub> (V) <sup>(19)</sup> |     |     |
|--------------|-----------------------|-----|-------|----------------------|-----|--------------------------------------|----------------------------------------|------|------------------------------------------|-----|-----|-------------------------------------|-----|-----|
|              | Min                   | Typ | Max   | Min                  | Max | Min                                  | Condition                              | Max  | Min                                      | Typ | Max | Min                                 | Typ | Max |
| HiSpi        | 2.375                 | 2.5 | 2.625 | 100                  | —   | 0.05                                 | D <sub>MAX</sub> ≤ 500 Mbps            | 1.8  | —                                        | —   | —   | —                                   | —   | —   |
|              |                       |     |       |                      |     | 0.55                                 | 500 Mbps ≤ D <sub>MAX</sub> ≤ 700 Mbps | 1.8  |                                          |     |     |                                     |     |     |
|              |                       |     |       |                      |     | 1.05                                 | D <sub>MAX</sub> > 700 Mbps            | 1.55 |                                          |     |     |                                     |     |     |

### Related Information

[Intel MAX 10 LVDS SERDES I/O Standards Support](#), [Intel MAX 10 High-Speed LVDS I/O User Guide](#)  
Provides the list of I/O standards supported in single supply and dual supply devices.

## Switching Characteristics

This section provides the performance characteristics of Intel MAX 10 core and periphery blocks.

<sup>(18)</sup> V<sub>IN</sub> range: 0 V ≤ V<sub>IN</sub> ≤ 1.85 V.

<sup>(19)</sup> R<sub>L</sub> range: 90 Ω ≤ R<sub>L</sub> ≤ 110 Ω.

<sup>(20)</sup> Low V<sub>OD</sub> setting is only supported for RSDS standard.

<sup>(22)</sup> No fixed V<sub>IN</sub>, V<sub>OD</sub>, and V<sub>OS</sub> specifications for Bus LVDS (BLVDS). They are dependent on the system topology.

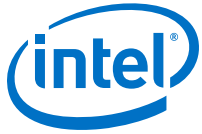
<sup>(23)</sup> Mini-LVDS, RSDS, and Point-to-Point Differential Signaling (PPDS) standards are only supported at the output pins for Intel MAX 10 devices.

<sup>(24)</sup> Supported with requirement of an external level shift

<sup>(25)</sup> Sub-LVDS input buffer is using 2.5 V differential buffer.

<sup>(26)</sup> Differential output depends on the values of the external termination resistors.

<sup>(27)</sup> Differential output offset voltage depends on the values of the external termination resistors.



## Core Performance Specifications

### Clock Tree Specifications

Table 26. Clock Tree Specifications for Intel MAX 10 Devices

| Device | Performance |          |     |     |     | Unit |
|--------|-------------|----------|-----|-----|-----|------|
|        | -I6         | -A6, -C7 | -I7 | -A7 | -C8 |      |
| 10M02  | 450         | 416      | 416 | 382 | 402 | MHz  |
| 10M04  | 450         | 416      | 416 | 382 | 402 | MHz  |
| 10M08  | 450         | 416      | 416 | 382 | 402 | MHz  |
| 10M16  | 450         | 416      | 416 | 382 | 402 | MHz  |
| 10M25  | 450         | 416      | 416 | 382 | 402 | MHz  |
| 10M40  | 450         | 416      | 416 | 382 | 402 | MHz  |
| 10M50  | 450         | 416      | 416 | 382 | 402 | MHz  |

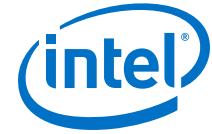
### PLL Specifications

Table 27. PLL Specifications for Intel MAX 10 Devices

$V_{CCD\_PLL}$  should always be connected to  $V_{CCINT}$  through decoupling capacitor and ferrite bead.

| Symbol          | Parameter                                      | Condition | Min | Typ | Max   | Unit |
|-----------------|------------------------------------------------|-----------|-----|-----|-------|------|
| $f_{IN}^{(28)}$ | Input clock frequency                          | —         | 5   | —   | 472.5 | MHz  |
| $f_{INPFD}$     | Phase frequency detector (PFD) input frequency | —         | 5   | —   | 325   | MHz  |
| continued...    |                                                |           |     |     |       |      |

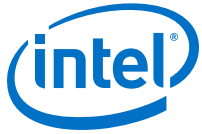
(28) This parameter is limited in the Intel Quartus Prime software by the I/O maximum frequency. The maximum I/O frequency is different for each I/O standard.



| Symbol                                      | Parameter                                                        | Condition                                                                                           | Min | Typ | Max   | Unit |
|---------------------------------------------|------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------|-----|-----|-------|------|
| $f_{VCO}$ <sup>(29)</sup>                   | PLL internal voltage-controlled oscillator (VCO) operating range | —                                                                                                   | 600 | —   | 1300  | MHz  |
| $f_{INDUTY}$                                | Input clock duty cycle                                           | —                                                                                                   | 40  | —   | 60    | %    |
| $t_{INJITTER\_CCJ}$ <sup>(30)</sup>         | Input clock cycle-to-cycle jitter                                | $F_{INPFD} \geq 100$ MHz                                                                            | —   | —   | 0.15  | UI   |
|                                             |                                                                  | $F_{INPFD} < 100$ MHz                                                                               | —   | —   | ±750  | ps   |
| $f_{OUT\_EXT}$ <sup>(28)</sup>              | PLL output frequency for external clock output                   | —                                                                                                   | —   | —   | 472.5 | MHz  |
| $f_{OUT}$                                   | PLL output frequency to global clock                             | –6 speed grade                                                                                      | —   | —   | 472.5 | MHz  |
|                                             |                                                                  | –7 speed grade                                                                                      | —   | —   | 450   | MHz  |
|                                             |                                                                  | –8 speed grade                                                                                      | —   | —   | 402.5 | MHz  |
| $t_{OUTDUTY}$                               | Duty cycle for external clock output                             | Duty cycle set to 50%                                                                               | 45  | 50  | 55    | %    |
| $t_{LOCK}$                                  | Time required to lock from end of device configuration           | —                                                                                                   | —   | —   | 1     | ms   |
| $t_{DLOCK}$                                 | Time required to lock dynamically                                | After switchover, reconfiguring any non-post-scale counters or delays, or when areset is deasserted | —   | —   | 1     | ms   |
| $t_{OUTJITTER\_PERIOD\_IO}$ <sup>(31)</sup> | Regular I/O period jitter                                        | $F_{OUT} \geq 100$ MHz                                                                              | —   | —   | 650   | ps   |
|                                             |                                                                  | $F_{OUT} < 100$ MHz                                                                                 | —   | —   | 75    | mUI  |
| $t_{OUTJITTER\_CCJ\_IO}$ <sup>(31)</sup>    | Regular I/O cycle-to-cycle jitter                                | $F_{OUT} \geq 100$ MHz                                                                              | —   | —   | 650   | ps   |
|                                             |                                                                  | $F_{OUT} < 100$ MHz                                                                                 | —   | —   | 75    | mUI  |

continued...

- <sup>(29)</sup> The VCO frequency reported by the Intel Quartus Prime software in the PLL summary section of the compilation report takes into consideration the VCO post-scale counter K value. Therefore, if the counter K has a value of 2, the frequency reported can be lower than the  $f_{VCO}$  specification.
- <sup>(30)</sup> A high input jitter directly affects the PLL output jitter. To have low PLL output clock jitter, you must provide a clean clock source, which is less than 200 ps.
- <sup>(31)</sup> Peak-to-peak jitter with a probability level of  $10^{-12}$  (14 sigma, 99.9999999974404% confidence level). The output jitter specification applies to the intrinsic jitter of the PLL, when an input jitter of 30 ps is applied.



| Symbol           | Parameter                                         | Condition | Min | Typ                 | Max | Unit           |
|------------------|---------------------------------------------------|-----------|-----|---------------------|-----|----------------|
| $t_{PLL\_PSERR}$ | Accuracy of PLL phase shift                       | —         | —   | —                   | ±50 | ps             |
| $t_{ARESET}$     | Minimum pulse width on areset signal.             | —         | 10  | —                   | —   | ns             |
| $t_{CONFIGPLL}$  | Time required to reconfigure scan chains for PLLs | —         | —   | 3.5 <sup>(32)</sup> | —   | SCANCLK cycles |
| $f_{SCANCLK}$    | scanclk frequency                                 | —         | —   | —                   | 100 | MHz            |

**Table 28. PLL Specifications for Intel MAX 10 Single Supply Devices**

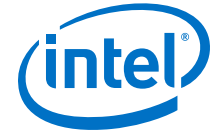
For V36 package, the PLL specification is based on single supply devices.

| Symbol                                          | Parameter                                    | Condition              | Max | Unit |
|-------------------------------------------------|----------------------------------------------|------------------------|-----|------|
| $t_{OUTJITTER\_PERIOD\_DEDCLK}$ <sup>(31)</sup> | Dedicated clock output period jitter         | $F_{OUT} \geq 100$ MHz | 660 | ps   |
|                                                 |                                              | $F_{OUT} < 100$ MHz    | 66  | mUI  |
| $t_{OUTJITTER\_CCJ\_DEDCLK}$ <sup>(31)</sup>    | Dedicated clock output cycle-to-cycle jitter | $F_{OUT} \geq 100$ MHz | 660 | ps   |
|                                                 |                                              | $F_{OUT} < 100$ MHz    | 66  | mUI  |

**Table 29. PLL Specifications for Intel MAX 10 Dual Supply Devices**

| Symbol                                          | Parameter                                    | Condition              | Max | Unit |
|-------------------------------------------------|----------------------------------------------|------------------------|-----|------|
| $t_{OUTJITTER\_PERIOD\_DEDCLK}$ <sup>(31)</sup> | Dedicated clock output period jitter         | $F_{OUT} \geq 100$ MHz | 300 | ps   |
|                                                 |                                              | $F_{OUT} < 100$ MHz    | 30  | mUI  |
| $t_{OUTJITTER\_CCJ\_DEDCLK}$ <sup>(31)</sup>    | Dedicated clock output cycle-to-cycle jitter | $F_{OUT} \geq 100$ MHz | 300 | ps   |
|                                                 |                                              | $F_{OUT} < 100$ MHz    | 30  | mUI  |

<sup>(32)</sup> With 100 MHz scanclk frequency.



## ADC Performance Specifications

### Single Supply Devices ADC Performance Specifications

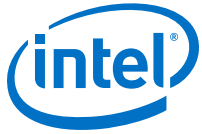
**Table 34. ADC Performance Specifications for Intel MAX 10 Single Supply Devices**

| Parameter                            |                            | Symbol        | Condition                            | Min                 | Typ             | Max           | Unit |
|--------------------------------------|----------------------------|---------------|--------------------------------------|---------------------|-----------------|---------------|------|
| ADC resolution                       |                            | —             | —                                    | —                   | —               | 12            | bits |
| ADC supply voltage                   |                            | $V_{CC\_ONE}$ | —                                    | 2.85                | 3.0/3.3         | 3.465         | V    |
| External reference voltage           |                            | $V_{REF}$     | —                                    | $V_{CC\_ONE} - 0.5$ | —               | $V_{CC\_ONE}$ | V    |
| Sampling rate                        |                            | $F_S$         | Accumulative sampling rate           | —                   | —               | 1             | MSPS |
| Operating junction temperature range |                            | $T_J$         | —                                    | −40                 | 25              | 125           | °C   |
| Analog input voltage                 |                            | $V_{IN}$      | Prescaler disabled                   | 0                   | —               | $V_{REF}$     | V    |
|                                      |                            |               | Prescaler enabled <sup>(35)</sup>    | 0                   | —               | 3.6           | V    |
| Input resistance                     |                            | $R_{IN}$      | —                                    | —                   | <sup>(36)</sup> | —             | —    |
| Input capacitance                    |                            | $C_{IN}$      | —                                    | —                   | <sup>(36)</sup> | —             | —    |
| DC Accuracy                          | Offset error and drift     | $E_{offset}$  | Prescaler disabled                   | −0.2                | —               | 0.2           | %FS  |
|                                      |                            |               | Prescaler enabled                    | −0.5                | —               | 0.5           | %FS  |
|                                      | Gain error and drift       | $E_{gain}$    | Prescaler disabled                   | −0.5                | —               | 0.5           | %FS  |
|                                      |                            |               | Prescaler enabled                    | −0.75               | —               | 0.75          | %FS  |
|                                      | Differential non linearity | DNL           | External $V_{REF}$ , no missing code | −0.9                | —               | 0.9           | LSB  |
|                                      |                            |               | Internal $V_{REF}$ , no missing code | −1                  | —               | 1.7           | LSB  |

*continued...*

<sup>(35)</sup> Prescaler function divides the analog input voltage by half. The analog input handles up to 3.6 V for the Intel MAX 10 single supply devices.

<sup>(36)</sup> Download the SPICE models for simulation.



| Parameter                  | Symbol                         | Condition                            | Min                                                           | Typ                                         | Max | Unit |
|----------------------------|--------------------------------|--------------------------------------|---------------------------------------------------------------|---------------------------------------------|-----|------|
|                            |                                | Internal $V_{REF}$ , no missing code | -1                                                            | —                                           | 1.7 | LSB  |
|                            | Integral non linearity         | INL                                  | —                                                             | —                                           | 2   | LSB  |
| AC Accuracy                | Total harmonic distortion      | THD                                  | $F_{IN} = 50 \text{ kHz}, F_S = 1 \text{ MHz}, \text{PLL}$    | -70 <sup>(44)(45)</sup><br><sub>(46)</sub>  | —   | dB   |
|                            | Signal-to-noise ratio          | SNR                                  | $F_{IN} = 50 \text{ kHz}, F_S = 1 \text{ MHz}, \text{PLL}$    | 62 <sup>(47)(48)</sup> <sub>(46)</sub>      | —   | dB   |
|                            | Signal-to-noise and distortion | SINAD                                | $F_{IN} = 50 \text{ kHz}, F_S = 1 \text{ MHz}, \text{PLL}$    | 61.5 <sup>(49)</sup><br><sub>(50)(46)</sub> | —   | dB   |
| On-Chip Temperature Sensor | Temperature sampling rate      | $T_S$                                | —                                                             | —                                           | 50  | kSPS |
|                            | Absolute accuracy              | —                                    | -40 to 125°C,<br>with 64 samples averaging<br><sub>(51)</sub> | —                                           | ±5  | °C   |
| continued...               |                                |                                      |                                                               |                                             |     |      |

(44) Total harmonic distortion is -65 dB for dual function pin.

(45) THD with prescaler enabled is 6dB less than the specification.

(46) When using internal  $V_{REF}$ , THD = 66 dB, SNR = 58 dB and SINAD = 57.5 dB for dedicated ADC input channels.

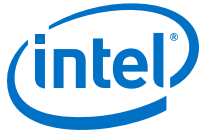
(47) Signal-to-noise ratio is 54 dB for dual function pin.

(48) SNR with prescaler enabled is 6dB less than the specification.

(49) Signal-to-noise and distortion is 53 dB for dual function pin.

(50) SINAD with prescaler enabled is 6dB less than the specification.

(51) For the Intel Quartus Prime software version 15.0 and later, Modular ADC Core and Modular Dual ADC Core IP cores handle the 64 samples averaging. For the Intel Quartus Prime software versions prior to 14.1, you need to implement your own averaging calculation.



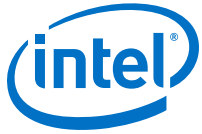
## Dual Supply Devices True RSDS and Emulated RSDS\_E\_3R Transmitter Timing Specifications

**Table 38. True RSDS and Emulated RSDS\_E\_3R Transmitter Timing Specifications for Intel MAX 10 Dual Supply Devices**

True **RSDS** transmitter is only supported at bottom I/O banks. Emulated **RSDS** transmitter is supported at the output pin of all I/O banks.

| Symbol            | Parameter                                              | Mode | -I6, -A6, -C7, -I7 |     |     | -A7 |     |     | -C8 |     |     | Unit |
|-------------------|--------------------------------------------------------|------|--------------------|-----|-----|-----|-----|-----|-----|-----|-----|------|
|                   |                                                        |      | Min                | Typ | Max | Min | Typ | Max | Min | Typ | Max |      |
| f <sub>HCLK</sub> | Input clock frequency (high-speed I/O performance pin) | ×10  | 5                  | —   | 155 | 5   | —   | 155 | 5   | —   | 155 | MHz  |
|                   |                                                        | ×8   | 5                  | —   | 155 | 5   | —   | 155 | 5   | —   | 155 | MHz  |
|                   |                                                        | ×7   | 5                  | —   | 155 | 5   | —   | 155 | 5   | —   | 155 | MHz  |
|                   |                                                        | ×4   | 5                  | —   | 155 | 5   | —   | 155 | 5   | —   | 155 | MHz  |
|                   |                                                        | ×2   | 5                  | —   | 155 | 5   | —   | 155 | 5   | —   | 155 | MHz  |
|                   |                                                        | ×1   | 5                  | —   | 310 | 5   | —   | 310 | 5   | —   | 310 | MHz  |
| HSIODR            | Data rate (high-speed I/O performance pin)             | ×10  | 100                | —   | 310 | 100 | —   | 310 | 100 | —   | 310 | Mbps |
|                   |                                                        | ×8   | 80                 | —   | 310 | 80  | —   | 310 | 80  | —   | 310 | Mbps |
|                   |                                                        | ×7   | 70                 | —   | 310 | 70  | —   | 310 | 70  | —   | 310 | Mbps |
|                   |                                                        | ×4   | 40                 | —   | 310 | 40  | —   | 310 | 40  | —   | 310 | Mbps |
|                   |                                                        | ×2   | 20                 | —   | 310 | 20  | —   | 310 | 20  | —   | 310 | Mbps |
|                   |                                                        | ×1   | 10                 | —   | 310 | 10  | —   | 310 | 10  | —   | 310 | Mbps |
| f <sub>HCLK</sub> | Input clock frequency (low-speed I/O performance pin)  | ×10  | 5                  | —   | 150 | 5   | —   | 150 | 5   | —   | 150 | MHz  |
|                   |                                                        | ×8   | 5                  | —   | 150 | 5   | —   | 150 | 5   | —   | 150 | MHz  |
|                   |                                                        | ×7   | 5                  | —   | 150 | 5   | —   | 150 | 5   | —   | 150 | MHz  |
|                   |                                                        | ×4   | 5                  | —   | 150 | 5   | —   | 150 | 5   | —   | 150 | MHz  |
|                   |                                                        | ×2   | 5                  | —   | 150 | 5   | —   | 150 | 5   | —   | 150 | MHz  |
|                   |                                                        | ×1   | 5                  | —   | 300 | 5   | —   | 300 | 5   | —   | 300 | MHz  |
| HSIODR            | Data rate (low-speed I/O performance pin)              | ×10  | 100                | —   | 300 | 100 | —   | 300 | 100 | —   | 300 | Mbps |
|                   |                                                        | ×8   | 80                 | —   | 300 | 80  | —   | 300 | 80  | —   | 300 | Mbps |
|                   |                                                        | ×7   | 70                 | —   | 300 | 70  | —   | 300 | 70  | —   | 300 | Mbps |

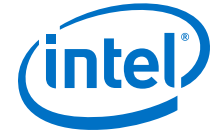
*continued...*



| Symbol                                   | Parameter                                                                                                              | Mode                               | -I6 |     |     | -A6, -C7, -I7 |     |     | -A7 |     |     | -C8 |     |     | Unit |
|------------------------------------------|------------------------------------------------------------------------------------------------------------------------|------------------------------------|-----|-----|-----|---------------|-----|-----|-----|-----|-----|-----|-----|-----|------|
|                                          |                                                                                                                        |                                    | Min | Typ | Max | Min           | Typ | Max | Min | Typ | Max | Min | Typ | Max |      |
|                                          |                                                                                                                        | ×1                                 | 10  | —   | 360 | 10            | —   | 350 | 10  | —   | 320 | 10  | —   | 320 | Mbps |
| t <sub>DUTY</sub>                        | Duty cycle on transmitter output clock                                                                                 | —                                  | 45  | —   | 55  | 45            | —   | 55  | 45  | —   | 55  | 45  | —   | 55  | %    |
| TCCS <sup>(65)</sup>                     | Transmitter channel-to-channel skew                                                                                    | —                                  | —   | —   | 300 | —             | —   | 300 | —   | —   | 300 | —   | —   | 300 | ps   |
| t <sub>x</sub><br>Jitter <sup>(66)</sup> | Output jitter                                                                                                          | —                                  | —   | —   | 380 | —             | —   | 380 | —   | —   | 380 | —   | —   | 380 | ps   |
| t <sub>RISE</sub>                        | Rise time                                                                                                              | 20 – 80%, C <sub>LOAD</sub> = 5 pF | —   | 500 | —   | —             | 500 | —   | —   | 500 | —   | —   | 500 | —   | ps   |
| t <sub>FALL</sub>                        | Fall time                                                                                                              | 20 – 80%, C <sub>LOAD</sub> = 5 pF | —   | 500 | —   | —             | 500 | —   | —   | 500 | —   | —   | 500 | —   | ps   |
| t <sub>LOCK</sub>                        | Time required for the PLL to lock, after CONF_DONE signal goes high, indicating the completion of device configuration | —                                  | —   | —   | 1   | —             | —   | 1   | —   | —   | 1   | —   | —   | 1   | ms   |

<sup>(65)</sup> TCCS specifications apply to I/O banks from the same side only.

<sup>(66)</sup> TX jitter is the jitter induced from core noise and I/O switching noise.



## LVDS, TMDs, HiSpi, SLVS, and Sub-LVDS Receiver Timing Specifications

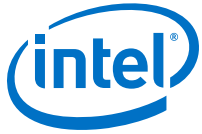
### Single Supply Devices LVDS Receiver Timing Specifications

**Table 45. LVDS Receiver Timing Specifications for Intel MAX 10 Single Supply Devices**

LVDS receivers are supported at all banks.

| Symbol            | Parameter                                              | Mode | -C7, -I7 |     | -A7 |     | -C8 |     | Unit |
|-------------------|--------------------------------------------------------|------|----------|-----|-----|-----|-----|-----|------|
|                   |                                                        |      | Min      | Max | Min | Max | Min | Max |      |
| $f_{\text{HCLK}}$ | Input clock frequency (high-speed I/O performance pin) | ×10  | 5        | 145 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×8   | 5        | 145 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×7   | 5        | 145 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×4   | 5        | 145 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×2   | 5        | 145 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×1   | 5        | 290 | 5   | 200 | 5   | 200 | MHz  |
| HSIODR            | Data rate (high-speed I/O performance pin)             | ×10  | 100      | 290 | 100 | 200 | 100 | 200 | Mbps |
|                   |                                                        | ×8   | 80       | 290 | 80  | 200 | 80  | 200 | Mbps |
|                   |                                                        | ×7   | 70       | 290 | 70  | 200 | 70  | 200 | Mbps |
|                   |                                                        | ×4   | 40       | 290 | 40  | 200 | 40  | 200 | Mbps |
|                   |                                                        | ×2   | 20       | 290 | 20  | 200 | 20  | 200 | Mbps |
|                   |                                                        | ×1   | 10       | 290 | 10  | 200 | 10  | 200 | Mbps |
| $f_{\text{HCLK}}$ | Input clock frequency (low-speed I/O performance pin)  | ×10  | 5        | 100 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×8   | 5        | 100 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×7   | 5        | 100 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×4   | 5        | 100 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×2   | 5        | 100 | 5   | 100 | 5   | 100 | MHz  |
|                   |                                                        | ×1   | 5        | 200 | 5   | 200 | 5   | 200 | MHz  |
| HSIODR            | Data rate (low-speed I/O performance pin)              | ×10  | 100      | 200 | 100 | 200 | 100 | 200 | Mbps |

*continued...*



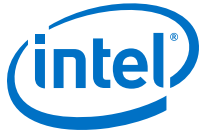
## JTAG Timing Parameters

**Table 49. JTAG Timing Parameters for Intel MAX 10 Devices**

The values are based on  $C_L = 10$  pF of TD0.

The affected Boundary Scan Test (BST) instructions are SAMPLE/PRELOAD, EXTEST, INTEST, and CHECK\_STATUS.

| Symbol          | Parameter                                | Non-BST and non-CONFIG_IO Operation |                                                                                                                                                             | BST and CONFIG_IO Operation |                                                                                                                                                             | Unit |
|-----------------|------------------------------------------|-------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
|                 |                                          | Minimum                             | Maximum                                                                                                                                                     | Minimum                     | Maximum                                                                                                                                                     |      |
| $t_{JCP}$       | TCK clock period                         | 40                                  | —                                                                                                                                                           | 50                          | —                                                                                                                                                           | ns   |
| $t_{JCH}$       | TCK clock high time                      | 20                                  | —                                                                                                                                                           | 25                          | —                                                                                                                                                           | ns   |
| $t_{JCL}$       | TCK clock low time                       | 20                                  | —                                                                                                                                                           | 25                          | —                                                                                                                                                           | ns   |
| $t_{JPSU\_TDI}$ | JTAG port setup time                     | 2                                   | —                                                                                                                                                           | 2                           | —                                                                                                                                                           | ns   |
| $t_{JPSU\_TMS}$ | JTAG port setup time                     | 3                                   | —                                                                                                                                                           | 3                           | —                                                                                                                                                           | ns   |
| $t_{JPH}$       | JTAG port hold time                      | 10                                  | —                                                                                                                                                           | 10                          | —                                                                                                                                                           | ns   |
| $t_{JPCO}$      | JTAG port clock to output                | —                                   | <ul style="list-style-type: none"><li>15 (for <math>V_{CCIO} = 3.3, 3.0,</math> and 2.5 V)</li><li>17 (for <math>V_{CCIO} = 1.8</math> and 1.5 V)</li></ul> | —                           | <ul style="list-style-type: none"><li>18 (for <math>V_{CCIO} = 3.3, 3.0,</math> and 2.5 V)</li><li>20 (for <math>V_{CCIO} = 1.8</math> and 1.5 V)</li></ul> | ns   |
| $t_{JPZX}$      | JTAG port high impedance to valid output | —                                   | <ul style="list-style-type: none"><li>15 (for <math>V_{CCIO} = 3.3, 3.0,</math> and 2.5 V)</li><li>17 (for <math>V_{CCIO} = 1.8</math> and 1.5 V)</li></ul> | —                           | <ul style="list-style-type: none"><li>15 (for <math>V_{CCIO} = 3.3, 3.0,</math> and 2.5 V)</li><li>17 (for <math>V_{CCIO} = 1.8</math> and 1.5 V)</li></ul> | ns   |
| $t_{JPXZ}$      | JTAG port valid output to high impedance | —                                   | <ul style="list-style-type: none"><li>15 (for <math>V_{CCIO} = 3.3, 3.0,</math> and 2.5 V)</li><li>17 (for <math>V_{CCIO} = 1.8</math> and 1.5 V)</li></ul> | —                           | <ul style="list-style-type: none"><li>15 (for <math>V_{CCIO} = 3.3, 3.0,</math> and 2.5 V)</li><li>17 (for <math>V_{CCIO} = 1.8</math> and 1.5 V)</li></ul> | ns   |



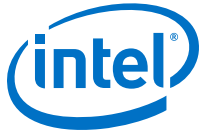
| Device | CFM Data Size (bits)          |                            |
|--------|-------------------------------|----------------------------|
|        | Without Memory Initialization | With Memory Initialization |
| 10M25  | 4,140,000                     | 4,780,000                  |
| 10M40  | 7,840,000                     | 9,670,000                  |
| 10M50  | 7,840,000                     | 9,670,000                  |

## Internal Configuration Time

The internal configuration time measurement is from the rising edge of nSTATUS signal to the rising edge of CONF\_DONE signal.

**Table 53. Internal Configuration Time for Intel MAX 10 Devices (Uncompressed .rbf)**

| Device | Internal Configuration Time (ms) |     |                            |     |                               |       |                            |       |
|--------|----------------------------------|-----|----------------------------|-----|-------------------------------|-------|----------------------------|-------|
|        | Unencrypted                      |     |                            |     | Encrypted                     |       |                            |       |
|        | Without Memory Initialization    |     | With Memory Initialization |     | Without Memory Initialization |       | With Memory Initialization |       |
|        | Min                              | Max | Min                        | Max | Min                           | Max   | Min                        | Max   |
| 10M02  | 0.3                              | 1.7 | —                          | —   | 1.7                           | 5.4   | —                          | —     |
| 10M04  | 0.6                              | 2.7 | 1.0                        | 3.4 | 5.0                           | 15.0  | 6.8                        | 19.6  |
| 10M08  | 0.6                              | 2.7 | 1.0                        | 3.4 | 5.0                           | 15.0  | 6.8                        | 19.6  |
| 10M16  | 1.1                              | 3.7 | 1.4                        | 4.5 | 9.3                           | 25.3  | 11.7                       | 31.5  |
| 10M25  | 1.0                              | 3.7 | 1.3                        | 4.4 | 14.0                          | 38.1  | 16.9                       | 45.7  |
| 10M40  | 2.6                              | 6.9 | 3.2                        | 9.8 | 41.5                          | 112.1 | 51.7                       | 139.6 |
| 10M50  | 2.6                              | 6.9 | 3.2                        | 9.8 | 41.5                          | 112.1 | 51.7                       | 139.6 |



**Table 56. I/O Timing for Intel MAX 10 Devices**

These I/O timing parameters are for the 3.3-V LVTTTL I/O standard with the maximum drive strength and fast slew rate for 10M08DAF484 device.

| Symbol          | Parameter                                              | -C7, -I7 | -C8    | Unit |
|-----------------|--------------------------------------------------------|----------|--------|------|
| T <sub>su</sub> | Global clock setup time                                | -0.750   | -0.808 | ns   |
| T <sub>h</sub>  | Global clock hold time                                 | 1.180    | 1.215  | ns   |
| T <sub>co</sub> | Global clock to output delay                           | 5.131    | 5.575  | ns   |
| T <sub>pd</sub> | Best case pin-to-pin propagation delay through one LUT | 4.907    | 5.467  | ns   |

## Programmable IOE Delay

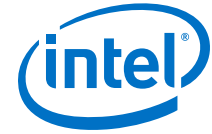
### Programmable IOE Delay On Row Pins

**Table 57. IOE Programmable Delay on Row Pins for Intel MAX 10 Devices**

The incremental values for the settings are generally linear. For exact values of each setting, refer to the **Assignment Name** column in the latest version of the Intel Quartus Prime software.

The minimum and maximum offset timing numbers are in reference to setting '0' as available in the Intel Quartus Prime software.

| Parameter                                | Paths Affected             | Number of Settings | Minimum Offset | Maximum Offset |       |             |       |       |       |       | Unit |
|------------------------------------------|----------------------------|--------------------|----------------|----------------|-------|-------------|-------|-------|-------|-------|------|
|                                          |                            |                    |                | Fast Corner    |       | Slow Corner |       |       |       |       |      |
|                                          |                            |                    |                | −I7            | −C8   | −A6         | −C7   | −C8   | −I7   | −A7   |      |
| Input delay from pin to internal cells   | Pad to I/O dataout to core | 7                  | 0              | 0.815          | 0.873 | 1.831       | 1.811 | 1.874 | 1.871 | 1.922 | ns   |
| Input delay from pin to input register   | Pad to I/O input register  | 8                  | 0              | 0.924          | 0.992 | 2.081       | 2.055 | 2.125 | 2.127 | 2.185 | ns   |
| Delay from output register to output pin | I/O output register to pad | 2                  | 0              | 0.479          | 0.514 | 1.069       | 1.070 | 1.117 | 1.105 | 1.134 | ns   |



| Date          | Version    | Changes                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|---------------|------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| December 2017 | 2017.12.15 | <ul style="list-style-type: none"> <li>Removed the units for "Input resistance" and "Input capacitance" parameters in the following tables: <ul style="list-style-type: none"> <li>ADC Performance Specifications for Intel MAX 10 Single Supply Devices</li> <li>ADC Performance Specifications for Intel MAX 10 Dual Supply Devices</li> </ul> </li> <li>Removed the specification with memory initialization for 10M02 device in the <i>Uncompressed .rbf Sizes for Intel MAX 10 Devices</i> table.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| June 2017     | 2017.06.16 | <ul style="list-style-type: none"> <li>Added notes for T<sub>J</sub> for Industrial and Automotive devices in Recommended Operating Conditions for Intel MAX 10 Devices table.</li> <li>Updated the parameter in Internal Weak Pull-Up Resistor for Intel MAX 10 Devices table.</li> <li>Changed "Performance" to "Frequency" in UFM Performance Specifications for Intel MAX 10 Devices table.</li> <li>Removed PowerPlay text from tool name.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| February 2017 | 2017.02.21 | <ul style="list-style-type: none"> <li>Rebranded as Intel.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| October 2016  | 2016.10.31 | <ul style="list-style-type: none"> <li>Updated the note to the Intel MAX 10 Device Grades and Speed Grades Supported table.</li> <li>Updated the Memory Standards Supported by the Soft Memory Controller for Intel MAX 10 Devices table.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| May 2016      | 2016.05.02 | <ul style="list-style-type: none"> <li>Updated t<sub>RAMP</sub> specifications in Recommended Operating Conditions for Intel MAX 10 Devices table. <ul style="list-style-type: none"> <li>Removed standard POR and fast POR specifications.</li> <li>Updated maximum value from 3 ms to 10 ms and added a not for the minimum value.</li> </ul> </li> <li>Added Supply Current and Power Consumption section.</li> <li>Added the following tables: <ul style="list-style-type: none"> <li>Memory Standards Supported by the Soft Memory Controller for Intel MAX 10 Devices</li> <li>Internal Configuration Timing Parameter for Intel MAX 10 Devices</li> </ul> </li> <li>Removed POR Delay Specifications for Intel MAX 10 Devices table.</li> <li>Updated the description in the Internal Configuration Time section.</li> <li>Updated the following tables: <ul style="list-style-type: none"> <li>Internal Configuration Time for Intel MAX 10 Devices (Uncompressed .rbf)</li> <li>Internal Configuration Time for Intel MAX 10 Devices (Compressed .rbf)</li> </ul> </li> </ul> |
| continued...  |            |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |